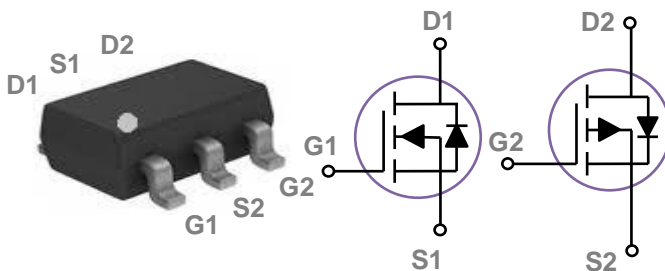


General Description

These N+P dual Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

SOT23-6 Dual Pin Configuration



BVDSS	RDSON	ID
30V	30mΩ	4A
-30V	65mΩ	-3A

Features

- Fast switching
- Green Device Available
- Suit for 4.5V Gate Drive Applications

Applications

- DC Fan
- Motor Drive Applications
- Networking
- Half / Full Bridge Topology

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating		Units
V_{DS}	Drain-Source Voltage	30	-30	V
V_{GS}	Gate-Source Voltage	± 20	± 20	V
I_D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	4	-3	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	2.5	-1.8	A
I_{DM}	Drain Current – Pulsed ¹	16	-12	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)	2		W
	Power Dissipation – Derate above 25°C	0.016		W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150		$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150		$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	100	$^\circ\text{C}/\text{W}$

N-CH Electrical Characteristics (T_J=25 °C, unless otherwise)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	30	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =30V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =24V, V _{GS} =0V, T _J =125°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =4A	---	22	30	mΩ
		V _{GS} =4.5V, I _D =2A	---	35	46	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.2	1.6	2.5	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	-4	---	mV/°C
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =3A	---	6.5	---	S

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{3, 4}	V _{DS} =15V, V _{GS} =4.5V, I _D =6A	---	4.1	8	nC
Q _{gs}	Gate-Source Charge ^{3, 4}		---	1	2	
Q _{gd}	Gate-Drain Charge ^{3, 4}		---	2.1	4	
T _{d(on)}	Turn-On Delay Time ^{3, 4}	V _{DD} =15V, V _{GS} =10V, R _G =6Ω I _D =1A	---	2.8	5	ns
T _r	Rise Time ^{3, 4}		---	7.2	14	
T _{d(off)}	Turn-Off Delay Time ^{3, 4}		---	15.8	30	
T _f	Fall Time ^{3, 4}		---	4.6	9	
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, F=1MHz	---	345	500	pF
C _{oss}	Output Capacitance		---	55	80	
C _{rss}	Reverse Transfer Capacitance		---	32	45	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	3.2	6.4	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	4	A
I _{SM}	Pulsed Source Current		---	---	8	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =1A, T _J =25°C	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

P-CH Electrical Characteristics (T_J=25 °C, unless otherwise)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30	---	---	V
ΔBV _{DSS} /ΔT _J	BV _{DSS} Temperature Coefficient	Reference to 25 °C , I _D =-1mA	---	-0.03	---	V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-30V , V _{GS} =0V , T _J =25 °C	---	---	-1	uA
		V _{DS} =-24V , V _{GS} =0V , T _J =125 °C	---	---	-10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =± 20V , V _{DS} =0V	---	---	± 100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V , I _D =-3A	---	45	65	mΩ
		V _{GS} =-4.5V , I _D =-2A	---	65	90	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-1.2	-1.6	-2.2	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	4	---	mV/°C
g _{fs}	Forward Transconductance	V _{DS} =-10V , I _D =-3A	---	3.7	---	S

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{2, 3}	V _{DS} =-30V , V _{GS} =-4.5V , I _D =-2A	---	5	8	nC
Q _{gs}	Gate-Source Charge ^{2, 3}		---	1.4	3	
Q _{gd}	Gate-Drain Charge ^{2, 3}		---	1.7	4	
T _{d(on)}	Turn-On Delay Time ^{2, 3}	V _{DD} =-30V , V _{GS} =-10V , R _G =6Ω I _D =-1A	---	3.4	6	ns
T _r	Rise Time ^{2, 3}		---	10.8	21	
T _{d(off)}	Turn-Off Delay Time ^{2, 3}		---	26.9	51	
T _f	Fall Time ^{2, 3}		---	6.9	13	
C _{iss}	Input Capacitance	V _{DS} =-30V , V _{GS} =0V , F=1MHz	---	420	810	pF
C _{oss}	Output Capacitance		---	50	80	
C _{rss}	Reverse Transfer Capacitance		---	35	60	

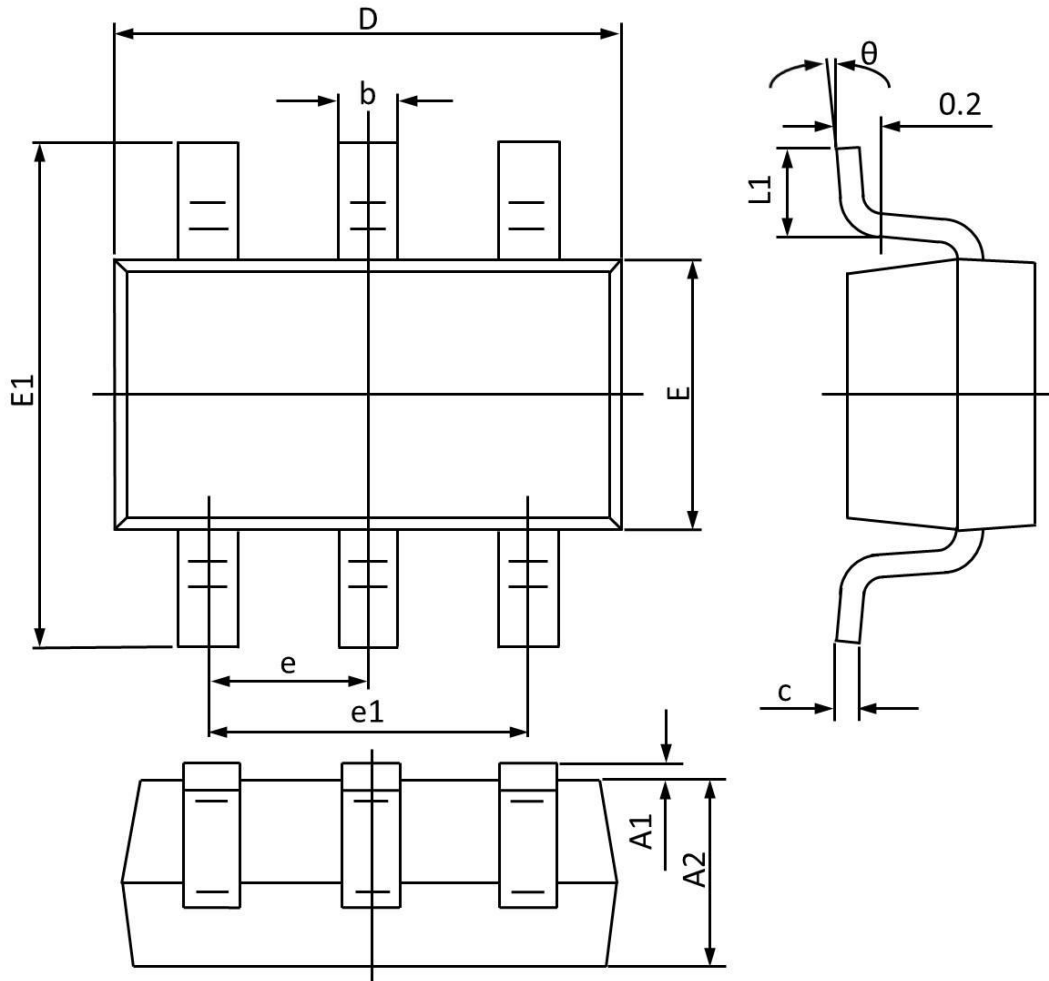
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V , Force Current	---	---	-3	A
I _{SM}	Pulsed Source Current		---	---	-6	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =-1A , T _J =25 °C	---	---	-1	V

Note :

4. Repetitive Rating : Pulsed width limited by maximum junction temperature.
5. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
6. Essentially independent of operating temperature.

SOT23-6 Dual PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A1	0.000	0.100	0.000	0.004
A2	1.000	1.200	0.040	0.047
b	0.300	0.500	0.012	0.019
c	0.047	0.207	0.002	0.008
D	2.800	3.000	0.110	0.118
E	1.500	1.800	0.059	0.070
E1	2.600	3.000	0.103	0.118
e	0.950 TYP		0.037 TYP	
e1	1.900 TYP		0.075 TYP	
L1	0.250	0.550	0.010	0.021
θ	0°	8°	0°	8°

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